



Flexible Thin Films and Nanomaterials in Electronic Materials

Guest Editor:

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Deadline for manuscript
submissions:

closed (15 December 2024)

Message from the Guest Editor

Dear Colleagues,

We are excited to announce that the *Flexible Thin Films and Nanomaterials in Electronic Materials* Section is now inviting submissions for this Special Issue of *Electronics*.

We invite submissions that cover a broad range of topics within, but not limited to, the following scope:

- Fabrication and application of flexible thin films in electronics;
- Innovations in nanomaterials for flexible and wearable devices;
- Advances in flexible electronic interfaces and sensors;
- Development and integration of flexible solar cells and energy storage devices;
- Flexible system-on-chip (SoC) designs and applications;
- Novel processes and materials for flexible integrated circuits;
- Durability, reliability, and performance optimization of flexible electronic materials;
- Theoretical and computational models of flexible electronic materials;
- Environmental impact and sustainability of flexible electronic material production.





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Editor-in-Chief

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Message from the Editor-in-Chief

Electronics is a multidisciplinary journal designed to appeal to a diverse audience of research scientists, practitioners, and developers in academia and industry. The journal is devoted to fast publication of latest technological breakthroughs, cutting-edge developments, and timely reviews of current and emerging technologies related to the broad field of electronics. Experimental and theoretical results are published as regular peer-reviewed articles or as articles within Special Issues guestedited by leading experts in selected topics of interest.

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